

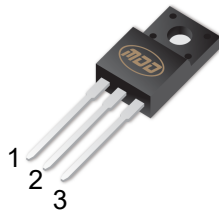


MDD7N65F/MDD7N65P/MDD7N65D

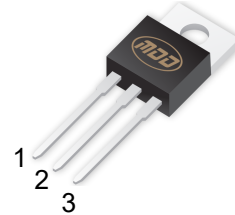
650V N-Channel Enhancement Mode MOSFET

V_{DS}	650 V
$I_D(T_C=25^\circ C)$	7A
$R_{DS(on),max}$	1.4Ω@ $V_{GS}=10V$
$Q_{g,typ}$	20.7nC

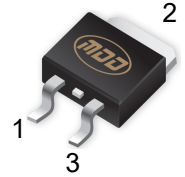
TO-220F-3L



TO-220-3L



TO-252



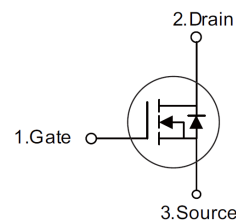
General Features

- Ultra low gate charge
- Low reverse transfer Capacitance
- Fast switching capability
- Avalanche energy tested
- Improved dv/dt capability, high ruggedness

Application

- High efficiency switch mode power supplies
- Electronic lamp ballasts based on half bridge
- LED power supplies

Equivalent Circuit



Absolute Maximum Ratings ($T_A=25^\circ C$ unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V_{DS}	650	V
Gate-Source Voltage	V_{GS}	±30	V
Continuous Drain Current	I_D	7	A
Pulsed Drain Current(Note 1)	I_{DM}	28	A
Avalanche Energy Single Pulsed (Note 2)	E_{AS}	352	mJ
Continuous diode forward current	I_S	7	A
Diode pulse current	$I_{S,pulse}$	28	A
Peak Diode Recovery dv/dt (Note 3)	dv/dt	5	V/ns
Power Dissipation TO-220F	P_D	39	W
Power Dissipation TO-220/TO-252		100	W
Junction Temperature	T_J	150	°C
Storage Temperature	T_{stg}	-55 ~ 150	°C

Thermal Characteristics

Parameter	Symbol	Value		Unit
		TO-220F	TO-220/TO-252	
Thermal resistance, Junction-to-case	$R_{\theta JC}$	3.2	1.25	°C/W
Thermal resistance, Junction-to-ambient	$R_{\theta JA}$	62.5	110	°C/W

- Notes:**
1. Pulse width limited by maximum junction temperature.
 2. L=10mH, $I_{AS} = 8.4A$, Starting $T_J = 25^\circ C$.
 3. $I_{SD} = 7A$, $di/dt \leq 100A/\mu s$, $V_{DD} \leq BV_{DS}$, Starting $T_J = 25^\circ C$.



MDD7N65F/MDD7N65P/MDD7N65D

650V N-Channel Enhancement Mode MOSFET

Ta = 25°C unless otherwise specified

Symbol	Parameter	Condition	Min	Typ	Max	Unit	
V _{(BR)DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V, I _D =250μA	650	--	--	V	
I _{GSS}	Gate-Source Leakage Current	Forward	V _{GS} =30V, V _{DS} =0V	--	--	100	nA
		Reverse	V _{GS} =-30V, V _{DS} =0V	--	--	-100	nA
I _{DSS}	Drain-Source Leakage Current	V _{DS} =650V, V _{GS} =0V	--	--	1	uA	
V _{GS(TH)}	Gate Threshold Voltage	V _{DS} =V _{GS} , I _D =250μA	2.0	--	4.0	V	
R _{DS(ON)}	Drain-Source On-State Resistance	V _{GS} =10V, I _D =3.5A	--	1.2	1.4	Ω	

Dynamic Electrical Characteristics

Symbol	Parameter	Condition	Min	Typ	Max	Unit
C _{iss}	Input Capacitance	V _{DS} =25V	--	1090		pF
C _{oss}	Output Capacitance	V _{GS} =0V	--	111		pF
C _{rss}	Reverse Transfer Capacitance	f=1MHz	--	6.1		pF
Q _g	Total Gate Charge	V _{DS} =520V,	--	20.7	--	nC
Q _{gs}	Gate Source Charge	V _{GS} =10V, I _D =7A	--	5.7	--	nC
Q _{gd}	Gate Drain Charge	(Note1,2)	--	7.2	--	nC

Switching Characteristics

Symbol	Parameter	Condition	Min	Typ	Max	Unit
t _{d(on)}	Turn on Delay Time	V _{DS} =325V, I _D =7A, R _G =10Ω (Note1,2)	--	--	12.2	ns
t _r	Turn on Rise Time		--	--	33.4	ns
t _{d(off)}	Turn Off Delay Time		--	--	53.6	ns
t _f	Turn Off Fall Time		--	--	15	ns

Source Drain Diode Characteristics

Symbol	Parameter	Condition	Min	Typ	Max	Unit
I _{SD}	Source drain current(Body Diode)		--	--	7	A
I _{SM}	Pulsed Current		--	--	28	A
V _{SD}	Drain-Source Diode Forward Voltage	I _S =7A, V _{GS} =0V	--	0.85	1.5	V
t _{rr}	Body Diode Reverse Recovery Time	V _R =325V I _F =7A,	--	373.2	--	ns
Q _{rr}	Body Diode Reverse Recovery Charge	-dI _F /dt =100A/μs	--	2.1	--	uC

Notes:

- 1.Pulse test ; Pulse width≤300us, duty cycles≤2%.
- 2.Essentially independent of operating temperature.



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650V N-Channel Enhancement Mode MOSFET

Electrical Characteristics Diagrams

Figure 1. Typical Output Characteristics

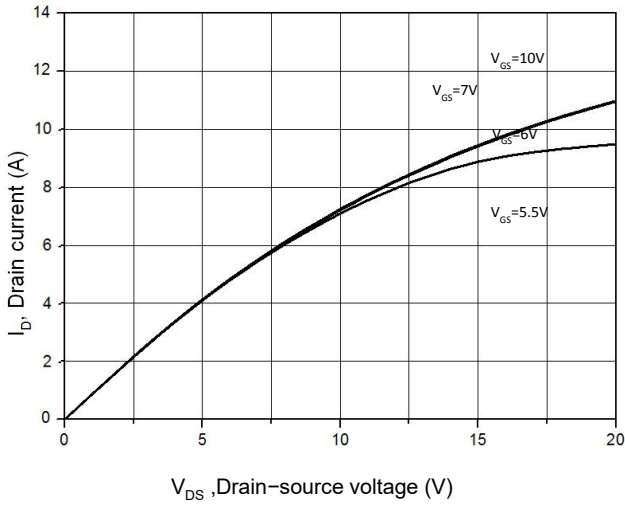


Figure 2. Transfer Characteristics

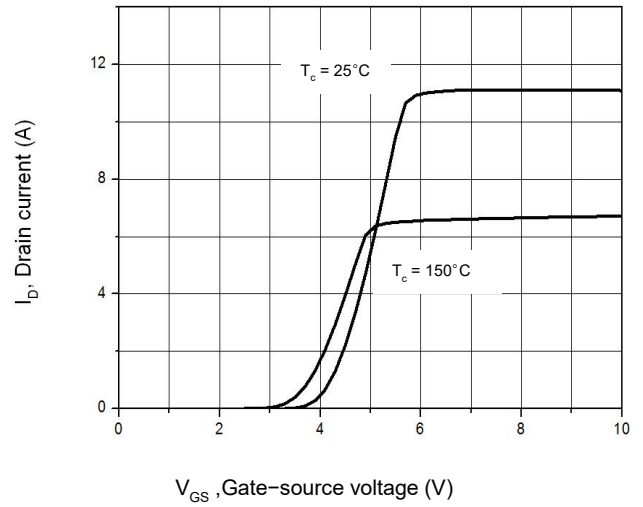


Figure 3. On-Resistance Variation vs. Drain Current

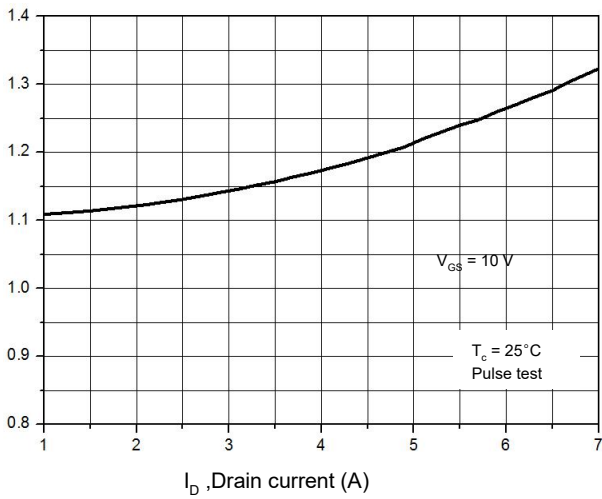


Figure 4. Threshold Voltage vs. Temperature

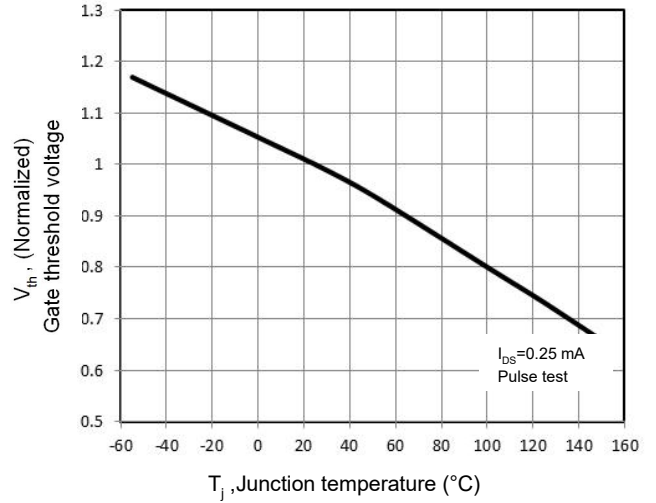


Figure 5. Breakdown Voltage vs. Temperature

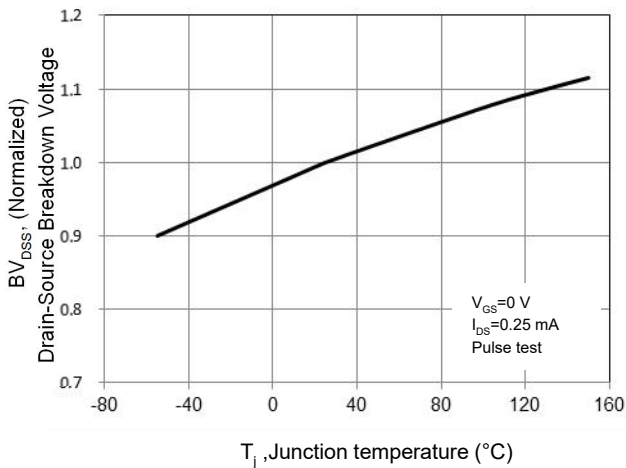
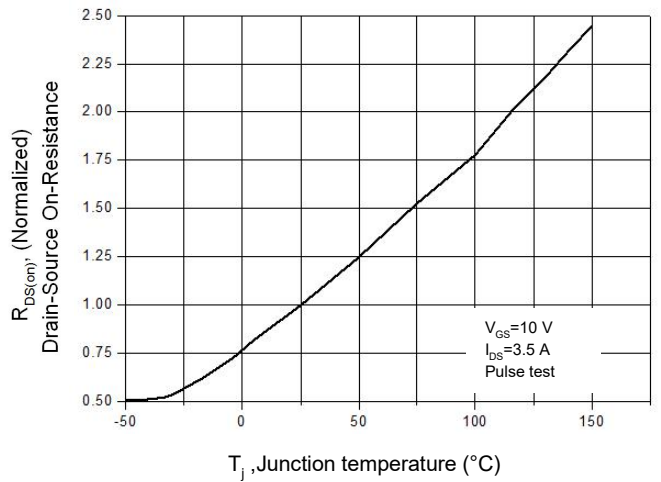


Figure 6. On-Resistance vs. Temperature





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Figure 7. Capacitance Characteristics

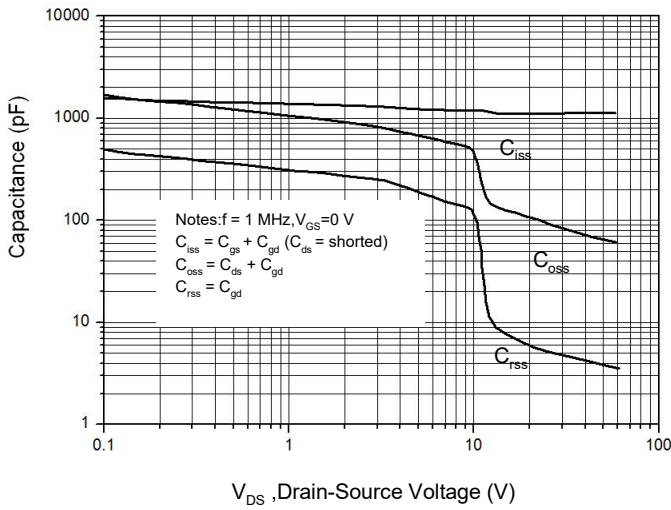


Figure 8. Gate Charge Characterist

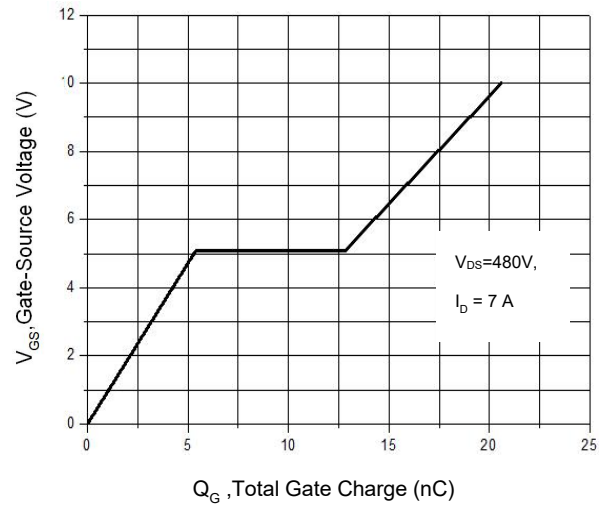


Figure 9. Maximum Safe Operating Area TO-220F

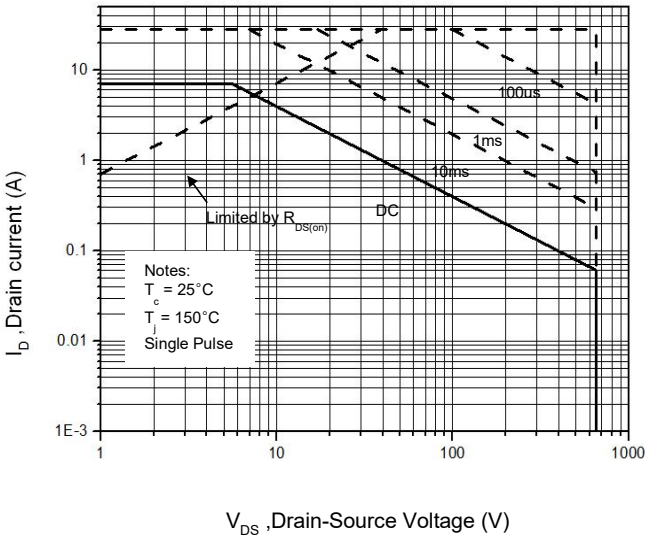


Figure 10. Maximum Safe Operating Area TO-220/ TO-252

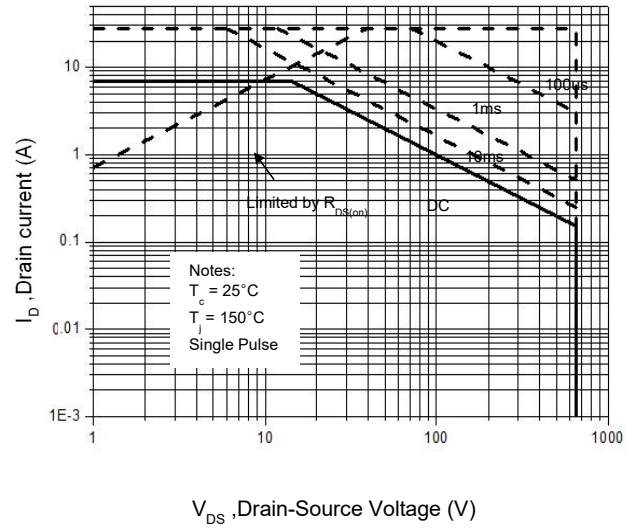


Figure 11. Power Dissipation vs. Temperature TO-220F

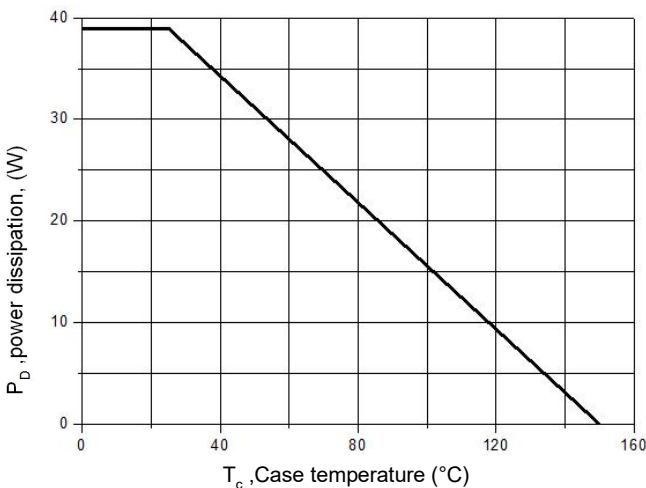
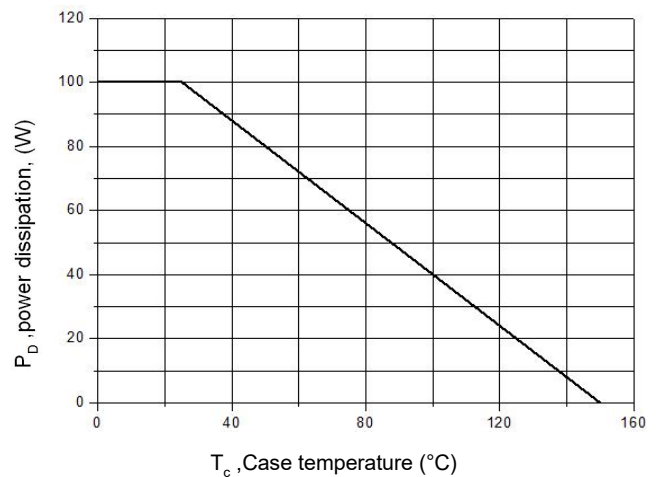


Figure 12. Power Dissipation vs. Temperature TO-220 / TO-252





MDD7N65F/MDD7N65P/MDD7N65D

650V N-Channel Enhancement Mode MOSFET

Figure 13. Continuous Drain Current vs. Temperature

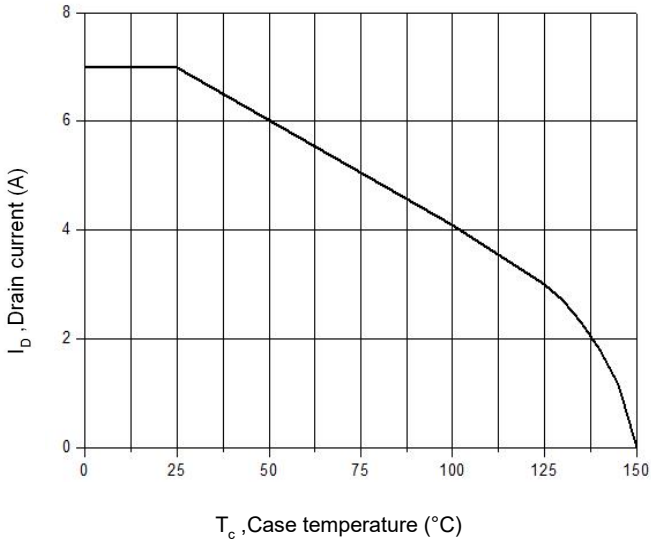


Figure 14. Body Diode Transfer Characteristics

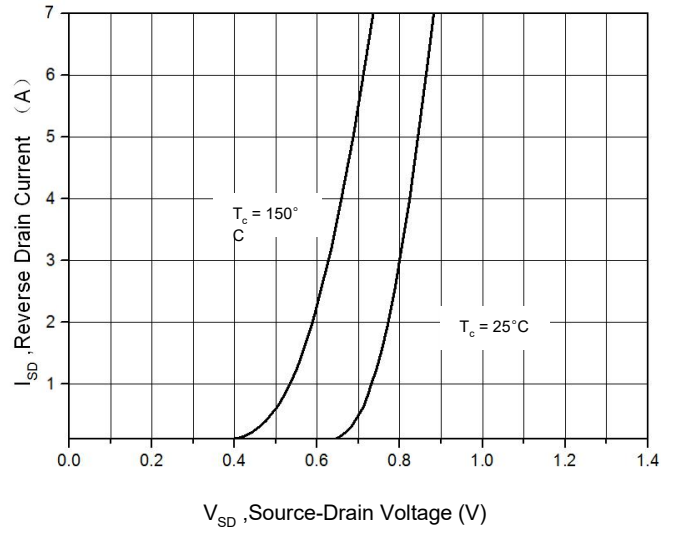


Figure 15 Transient Thermal Impedance, Junction to Case, TO-220F

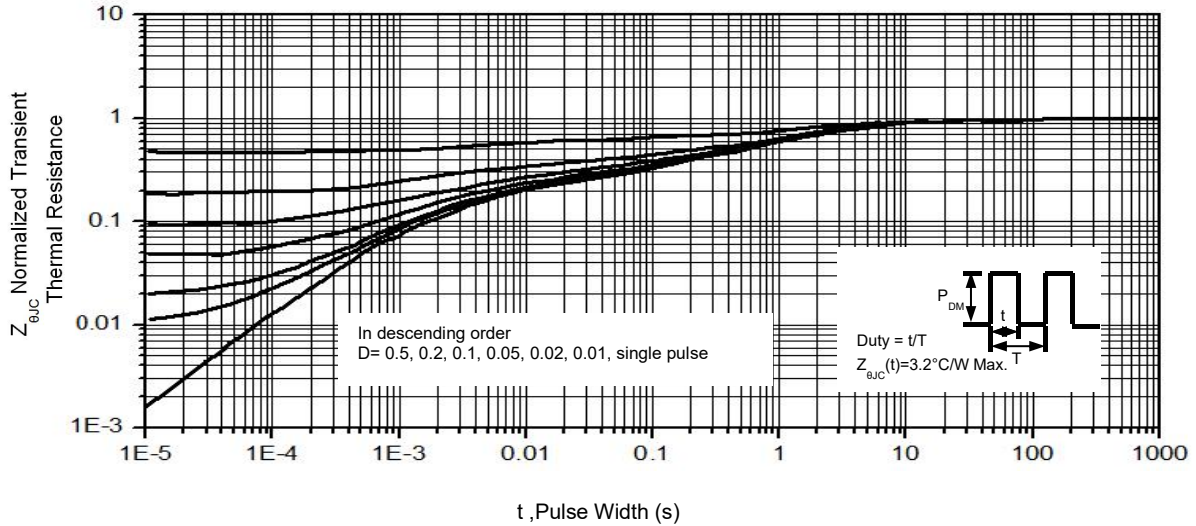
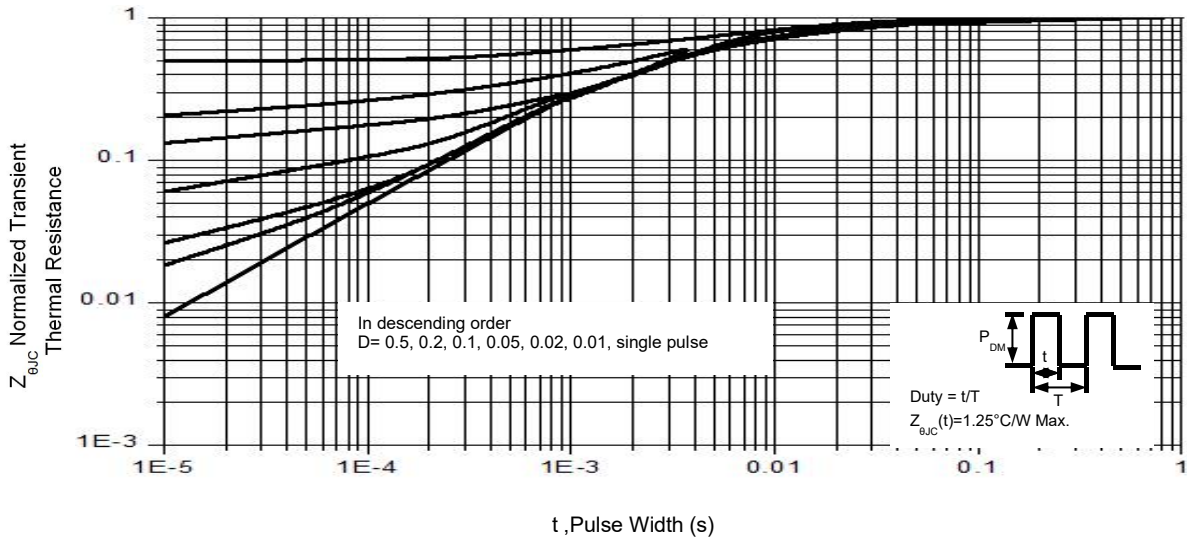
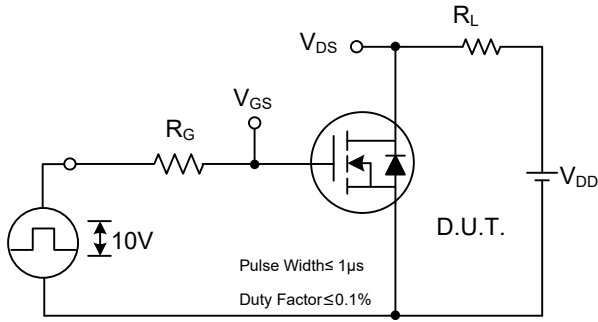
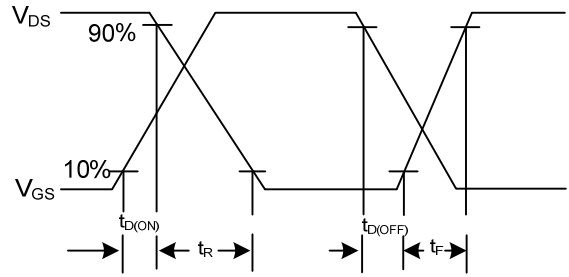


Figure 16. Transient Thermal Impedance, Junction to Case, TO-220/ TO-252

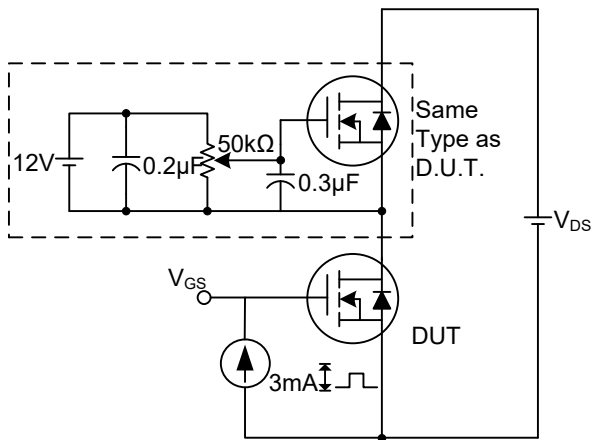




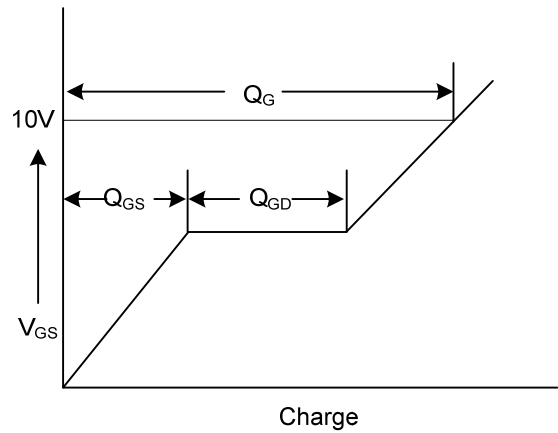
Switching Test Circuit



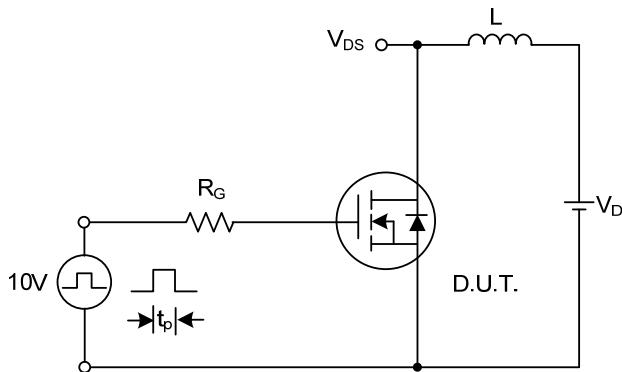
Switching Waveforms



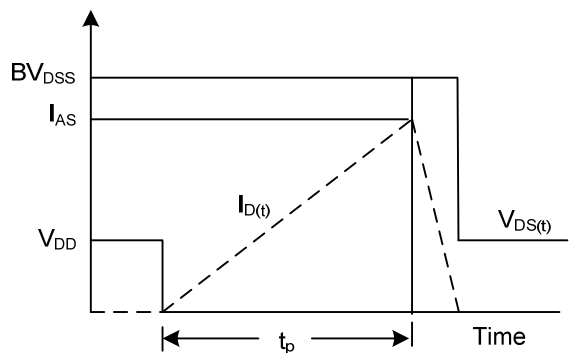
Gate Charge Test Circuit



Gate Charge Waveform



Unclamped Inductive Switching Test Circuit



Unclamped Inductive Switching Waveforms

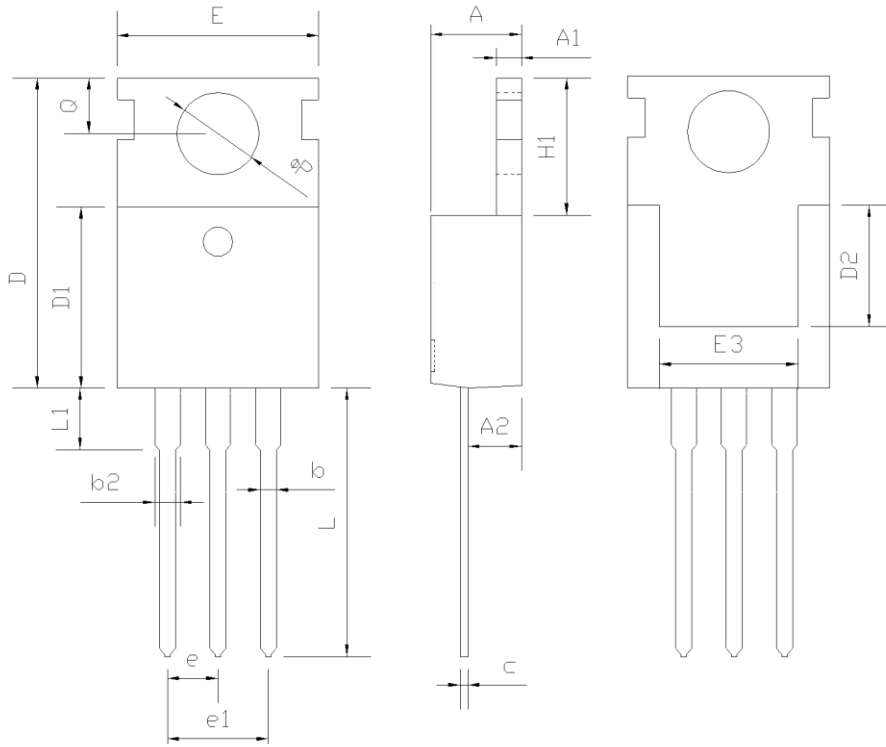
The curve above is for reference only.



MDD7N65F/MDD7N65P/MDD7N65D

650V N-Channel Enhancement Mode MOSFET

Mechanical Dimensions for TO-220



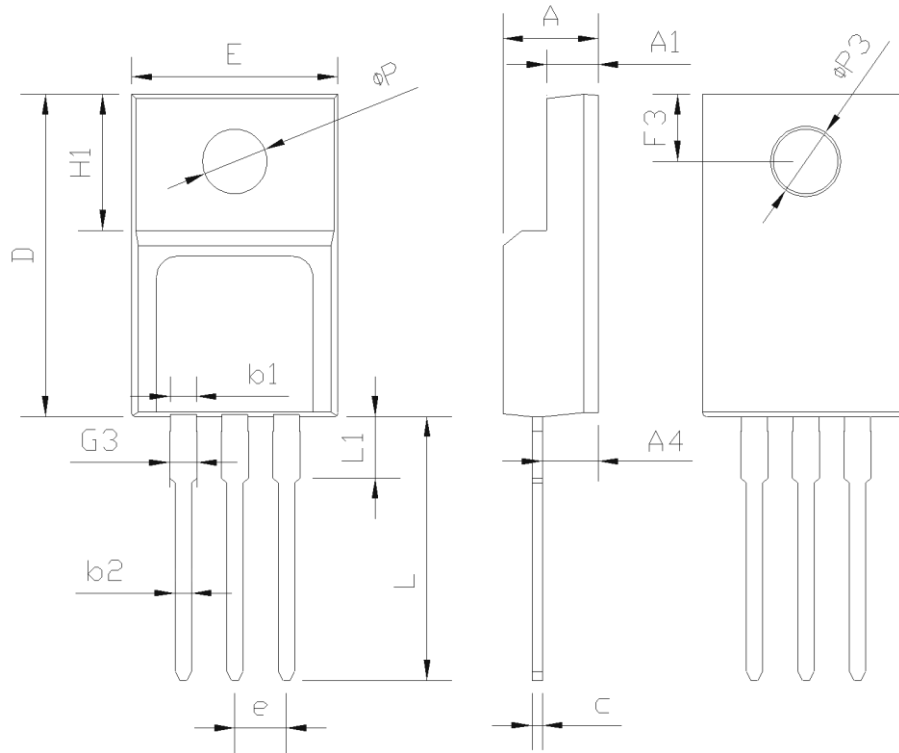
SYMBOL	mm		
	MIN	NOM	MAX
A	4.37	4.57	4.70
A1	1.25	1.30	1.40
A2	2.20	2.40	2.60
b	0.70	0.80	0.95
b2	1.17	1.27	1.47
c	0.45	0.50	0.60
D	15.10	15.60	16.10
D1	8.80	9.10	9.40
D2	5.50	-	-
E	9.70	10.00	10.30
E3	7.00	-	-
e	2.54 BSC		
e1	5.08 BSC		
H1	6.25	6.50	6.85
L	12.75	13.50	13.80
L1	-	3.10	3.40
ΦP	3.40	3.60	3.80
Q	2.60	2.80	3.00



MDD7N65F/MDD7N65P/MDD7N65D

650V N-Channel Enhancement Mode MOSFET

Mechanical Dimensions for TO-220F



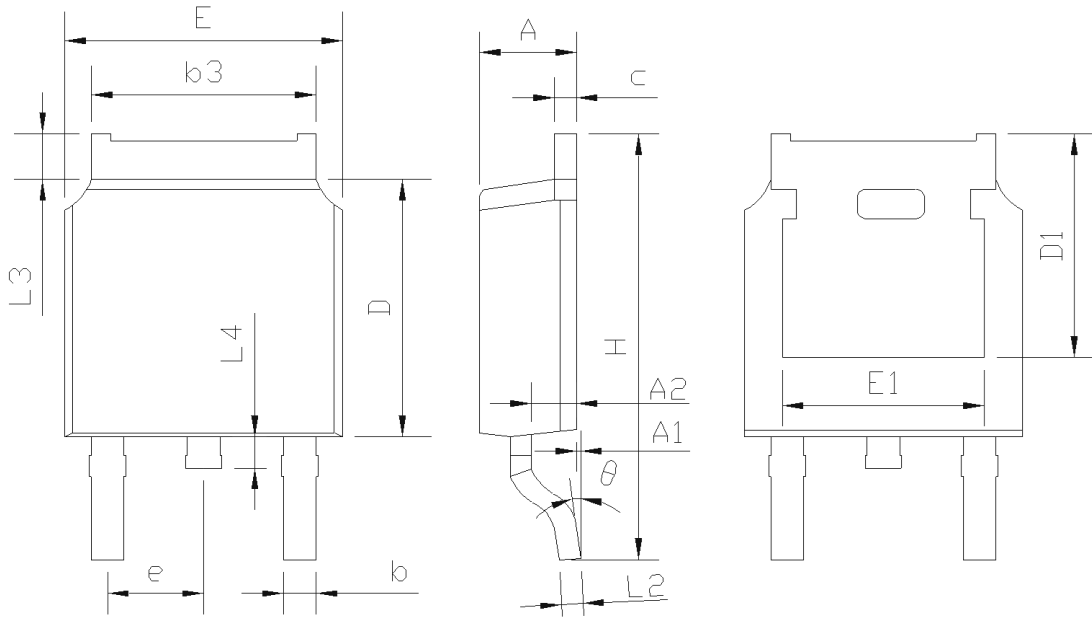
SYMBOL	mm		
	MIN	NOM	MAX
E	9.96	10.16	10.36
A	4.50	4.70	4.90
A1	2.34	2.54	2.74
A4	2.56	2.76	2.96
c	0.40	0.50	0.65
D	15.57	15.87	16.17
H1	6.70REF		
e	2.54BSC		
L	12.68	12.98	13.28
L1	2.88	3.03	3.18
ΦP	3.03	3.18	3.38
ΦP3	3.15	3.45	3.65
F3	3.15	3.30	3.45
G3	1.25	1.35	1.55
b1	1.18	1.28	1.43
b2	0.70	0.80	0.95



MDD7N65F/MDD7N65P/MDD7N65D

650V N-Channel Enhancement Mode MOSFET

Mechanical Dimensions for TO-252



SYMBOL	mm		
	MIN	NOM	MAX
A	2.20	2.30	2.38
A1	0.00	-	0.20
A2	0.97	1.07	1.17
b	0.68	0.78	0.90
b3	5.20	5.33	5.46
c	0.43	0.53	0.61
D	5.98	6.10	6.22
D1	5.30REF		
E	6.40	6.60	6.73
E1	4.63	-	-
e	2.286BSC		
H	9.40	10.10	10.50
L2	0.51BSC		
L3	0.88	-	1.28
L4	0.50	-	1.00
θ	0°	-	8°

Package Marking and Ordering Information

Part Number	Marking	Package	Units/Tube	Units/Reel
MDD7N65F	7N65F	TO-220F	50	
MDD7N65P	7N65P	TO-220-3L	50	
MDD7N65D	7N65D	TO-252		2500

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